

UNISONIC TECHNOLOGIES CO., LTD

42NM60Z **Preliminary Power MOSFET**

42A, 600V N-CHANNEL SUPER-JUNCTION MOSFET

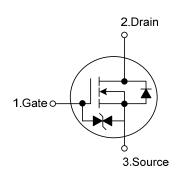
DESCRIPTION

The UTC 42NM60Z is an N-channel enhancement mode silicon-gate power MOSFET with fast body diode and ESD Type, designed for high-voltage, high-speed power switching applications. such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics.

FEATURES

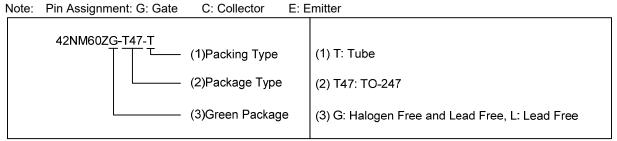
- * $R_{DS(ON)} \le 95 \text{ m}\Omega$ @ $V_{GS}=10V$, $I_{D}=10.5A$
- * Fast body diode MOSFET technology
- * Low switching losses due to reduced Qrr
- * Single Pulse Avalanche Energy Rated
- * Fast Switching Speeds
- * Linear Transfer Characteristics
- * High Input Impedance
- * Avalanche energy tested

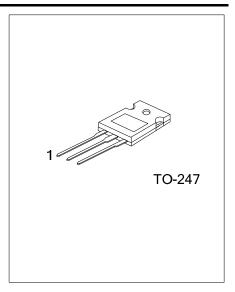
SYMBOL



ORDERING INFORMATION

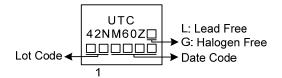
Ordering Number		Daakana	Pin Assignment			Dealing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
42NM60ZL-T47-T	42NM60ZG-T47-T	TO-247	G	D	S	Tube	





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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	600	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current	Continuous	I _D	42	Α
	Pulsed (Note 2)	Ірм	126	Α
Avalanche Energy	Single Pulsed (Note 3)	Eas	288	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.48	V/nS
Power Dissipation		P _D	160	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L =100mH, I_{AS} = 2.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. IsD \leq 30A, di/dt \leq 200A/ μ s, VDD \leq BVDSS, Starting TJ = 25°C

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	40	°C/W	
Junction to Case	θ_{JC}	0.78	°C/W	

Note: Device mounted on FR-4 substrate P_{C} board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

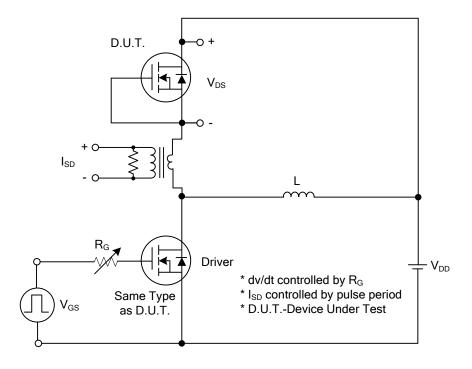
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	600			V
Drain-Source Leakage Current		IDSS	V _{DS} =600V, V _{GS} =0V			10	μΑ
Gate- Source Leakage Current	Forward	Igss	V _{GS} =+20V, V _{DS} =0V			+10	μA
	Reverse	IGSS	V _{GS} =-20V, V _{DS} =0V			-10	μΑ
ON CHARACTERISTICS	-						
Gate Threshold Voltage		$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =250µA	2.5		4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =10.5A			95	mΩ
DYNAMIC PARAMETERS							
Input Capacitance	out Capacitance				2682		рF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =50V, f=1.0MHz		977		рF
Reverse Transfer Capacitance		Crss			44		рF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q _G	V _{DS} =480V, V _{GS} =10V, I _D =42A		117		nC
Gate to Source Charge		Q _G s	(Note1, 2)		26		nC
Gate to Drain Charge		Q_{GD}	(Note 1, 2)		48		nC
Turn-ON Delay Time (Note 1)		t _{D(ON)}			42		ns
Rise Time		t _R	V _{DS} =100V, V _{GS} =10V, I _D =42A,		74		ns
Turn-OFF Delay Time		t _{D(OFF)}	R _G =25Ω (Note1, 2)		338		ns
Fall-Time		t⊧			129		ns
SOURCE- DRAIN DIODE RATING	S AND CH	ARACTERIST	TICS				
Maximum Body-Diode Continuous Current		Is				42	Α
Maximum Body-Diode Pulsed Current		Ism				126	Α
Drain-Source Diode Forward Voltage (Note 1)		V _{SD}	I _S =42A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	I _S =30A, V _{GS} =0V,		486		ns
Body Diode Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs		9.04		μC

Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.

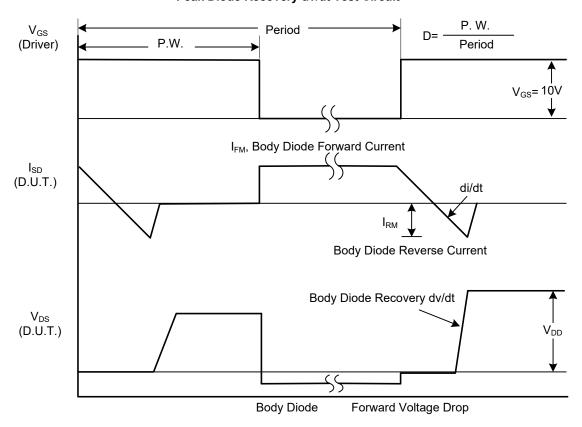
2. Essentially independent of operating ambient temperature.



■ TEST CIRCUITS AND WAVEFORMS



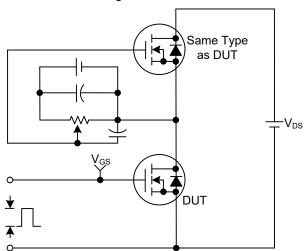
Peak Diode Recovery dv/dt Test Circuit



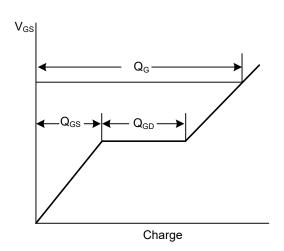
Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS

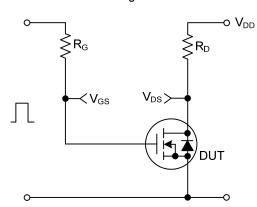
Gate Charge Test Circuit



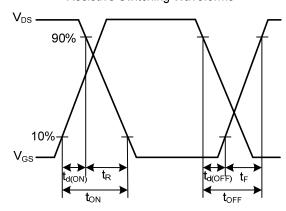
Gate Charge Waveforms



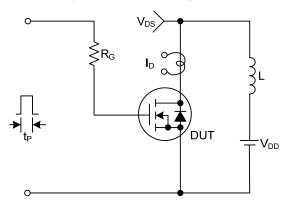
Resistive Switching Test Circuit



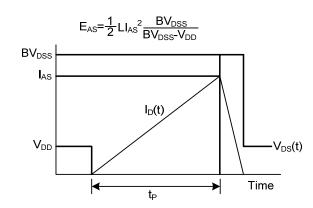
Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



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